

The charge transport mechanism and the nature of traps in charge trap flash, ReRAM and FeRAM devices

V.A. Gritsenko^{1,2,3*}

*1 Rzhanov Institute of Semiconductor Physics, SB RAS, 13 Lavrentyev ave.,
630090, Novosibirsk, Russia*

2 Novosibirsk State University, 2 Pirogov str., 630090, Novosibirsk, Russia

3 Novosibirsk State Technical University, 20 K. Marks ave, 630073, Novosibirsk, Russia

High- κ dielectrics HfO_x , ZrO_x , $\text{Hf}_{0.5}\text{Zr}_{0.5}\text{O}_2$, AlO_x , SiO_x , SiN_x are used now in charge trap flash (TANOS), ReRAM and FeRAM devices. In Si_3N_4 of TANOS the charge transport limited by multiphonon trap ionization [1]. It is proved that the traps responsible for memory effect is the Si-Si bonds [2]. Alumina is used in TANOS charge trap flash devices as blocking dielectric [1]. Electron transport in amorphous Al_2O_3 is limited by multiphonon trap ionization [3]. The luminescence band 3.0 eV in amorphous Al_2O_3 has excitation energy 6.0 eV [4]. The photoluminescence Stokes shift $(6.0-3.0)/2=1.5$ eV is equal to the thermal trap energy 1.5 eV. Quantum-chemical simulation shows that oxygen vacancy in alumina is electron trap.

The charge transport in high- κ dielectrics is determined by electron and hole traps. The charge transport in ReRAM based on HfO_2 is controlled by trap assisted tunneling between traps [5,6]. Thermal trap energy in HfO_2 is equal to 1.25 eV [6,7]. The trap nature in HfO_2 was studied with luminescence experiments. The blue luminescence band 2.7 eV has excitation energy 5.2 eV. The same energy has absorption peak of oxygen vacancy in HfO_2 . Hence, the 5.2 eV excitation peak and 2.7 eV luminescence band are related to oxygen vacancies [6]. The photoluminescence Stokes shift $(5.2-2.7)/2=1.25$ eV is equal to thermal trap energy. Hence, the oxygen vacancy in HfO_2 is electron trap [7,8]. Similar results were obtained for ZrO_2 . It was concluded that the oxygen vacancies in ZrO_2 are electron and hole traps.

$\text{Hf}_{0.5}\text{Zr}_{0.5}\text{O}_2$ is used as memory node in ferroelectric memory FeRAM. The charge transport in $\text{Hf}_{0.5}\text{Zr}_{0.5}\text{O}_2$ is limited by trap assisted tunneling between traps [9]. With photoluminescence experiments and quantum-chemical simulation it was found that oxygen vacancy in $\text{Hf}_{0.5}\text{Zr}_{0.5}\text{O}_2$ is electron trap.

[1] V.A. Gritsenko, Silicon Nitride on Si: Electronic Structure for Flash Memory Devices, chapter in book "Thin Films on Si: Electronic and Photonic Applications" p.273-322 "World Scientific Press", 2016

[2] V.A. Gritsenko, N.V. Perevalov, et al, Applied Physics Letters, v. 109, p. 06294, 2016

[3] N. Novikov, V.A. Gritsenko, K.A. Nasyrov, Appl. Phys. Lett. v. 94, p. 222904, 2009

[4] T.V. Perevalov, O.E. Tereshenko, V.A. Gritsenko, et al, J. Appl. Phys. v.108, p.013501, 2010

[5] D. R. Islamov, V. A. Gritsenko, et al Applied Physics Letters. v. 105, p. 222901, 2014

[6] V. A. Gritsenko, T. V. Perevalov, D. R. Islamov, Physics Reports, v. 613, p.1, 2016

[7] T.V. Perevalov, V.Sh. Aliev, Applied. Physics Letters, v.104, p. 071904, 2014

[8] V. Gritsenko; D. Islamov, T. V. Perevalov, et al, , J. Phys. Chem. C, v. 120, p 19980, 2016

[9] D. R. Islamov, T. V. Perevalov, et al, Appl. Phys. Lett. v. 106, p. 102906, 2015

* E-mail: grits@isp.nsc.ru